TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74AC109P,TC74AC109F,TC74AC109FN

#### Dual J-K Flip Flop with Preset and Clear

The TC74AC109 is an advanced high speed CMOS DUAL J- $\overline{K}$  FLIP FLOP fabricated with silicon gate and double-layer metal wiring C2MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

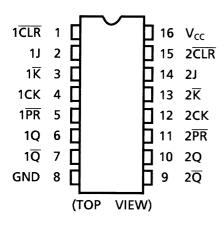
In accordance with the logic level given J and  $\overline{K}$  input this device changes state on positive going transition of the clock pulse.  $\overline{CLEAR}$  and  $\overline{PRESET}$  are independent of the clock and accomplished by a low logic level on the corresponding input.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

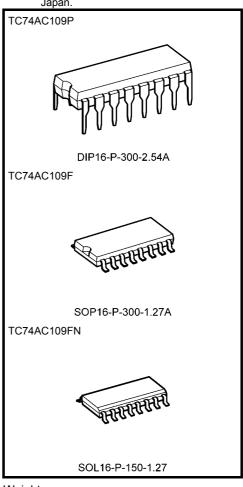
#### **Features**

- High speed:  $f_{max} = 200 \text{ MHz}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- High noise immunity: V<sub>NIH</sub> = V<sub>NIL</sub> = 28% V<sub>CC</sub> (min)
- Symmetrical output impedance:  $|I_{OH}| = I_{OL} = 24$  mA (min) Capability of driving 50  $\Omega$  transmission lines.
- Balanced propagation delays: tpLH ~ tpHL
- Wide operating voltage range: V<sub>CC</sub> (opr) = 2 to 5.5 V
- Pin and function compatible with 74F109

#### Pin Assignment



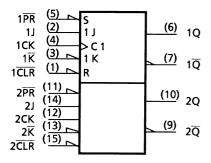
Note: xxxFN (JEDEC SOP) is not available in Japan.



Weight

DIP16-P-300-2.54A : 1.00 g (typ.) SOP16-P-300-1.27A : 0.18 g (typ.) SOL16-P-150-1.27 : 0.13 g (typ.)

# **IEC Logic Symbol**

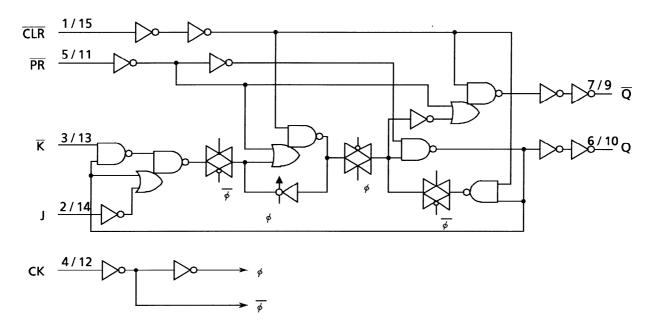


### **Truth Table**

		Inputs	Out	puts	Function		
CLR	PR	J	ĸ	CK	Q	Q	Function
L	Н	Х	Х	Х	L	Н	Clear
Н	L	Х	Х	Х	Н	L	Preset
L	L	Х	Х	Х	Н	Н	
Н	Н	L	Н	$\downarrow$	Qn	$\overline{Q}_n$	No Change
Н	Н	L	L		L	Н	
Н	Н	Н	Н		Н	L	
Н	Н	Н	L		$\overline{Q}_n$	Qn	Toggle
Н	Н	Х	Х	$\neg$	Qn	$\overline{Q}_n$	No Change

X: Don't care

# **System Diagram**



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#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	−0.5 to V <sub>CC</sub> + 0.5	٧
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	lok	±50	mA
DC output current	lout	±50	mA
DC V <sub>CC</sub> /ground current	Icc	±100	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T <sub>stg</sub>	–65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C should be applied up to 300 mW.

## **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2.0 to 5.5	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	−40 to 85	°C
Input rise and fall time	dt/dV	0 to 100 ( $V_{CC} = 3.3 \pm 0.3 \text{ V}$ ) 0 to 20 ( $V_{CC} = 5 \pm 0.5 \text{ V}$ )	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

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### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit			
Characteristics	Cymbol				V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Onic	
					2.0	1.50	_	_	1.50	_		
High-level input voltage	$V_{IH}$		_		3.0	2.10	_	_	2.10		V	
, and the second				5.5	3.85	_	_	3.85	_			
					2.0	_	_	0.50	_	0.50		
Low-level input voltage	$V_{IL}$		_		3.0	_	_	0.90	_	0.90	V	
, and the second					5.5	_	_	1.65	—	1.65		
					2.0	1.9	2.0	_	1.9	_	V	
	V <sub>ОН</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	3.0	2.9	3.0	_	2.9	_			
High-level output					4.5	4.4	4.5	_	4.4	_		
voltage			$I_{OH} = -4 \text{ mA}$		3.0	2.58	_	_	2.48	_	· I	
			$I_{OH} = -24 \text{ mA}$		4.5	3.94	_	_	3.80	_		
			$I_{OH} = -75 \text{ mA}$	(Note)	5.5		_	_	3.85	_		
	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>			2.0	_	0.0	0.1	_	0.1		
			$I_{OL} = 50 \mu A$		3.0	_	0.0	0.1	_	0.1		
Low-level output					4.5	_	0.0	0.1	_	0.1	V	
voltage			$I_{OL} = 12 \text{ mA}$		3.0	_	_	0.36	_	0.44	V	
			I <sub>OL</sub> = 24 mA		4.5	_	_	0.36	_	0.44		
			$I_{OL} = 75 \text{ mA}$	(Note)	5.5	_	_	_	_	1.65		
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5		_	±0.1	_	±1.0	μА		
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	4.0	_	40.0	μА		

Note: This spec indicates the capability of driving 50  $\Omega$  transmission lines.

One output should be tested at a time for a 10 ms maximum duration.



## Timing Requirements (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	Ta = 25°C	Ta = -40 to 85°C	Unit	
			V <sub>CC</sub> (V)	Limit	Limit	
Minimum pulse width	t <sub>W (L)</sub>		$3.3 \pm 0.3$	8.0	8.0	20
(CK)	t <sub>W (H)</sub>	_	$5.0 \pm 0.5$	5.0	5.0	ns
Minimum pulse width	4		$3.3 \pm 0.3$	7.0	7.0	20
( $\overline{\text{CLR}}$ , $\overline{\text{PR}}$ )	t <sub>W (L)</sub>	_	$5.0 \pm 0.5$	5.0	5.0	ns
Minimum oot un timo			$3.3 \pm 0.3$	9.0	9.0	
Minimum set-up time	t <sub>S</sub>		$5.0 \pm 0.5$	5.0	5.0	ns
Minimum hold time	4.		$3.3 \pm 0.3$	0.0	0.0	
Minimum noid time	t <sub>h</sub>	_	$5.0 \pm 0.5$	0.0	0.0	ns
Minimum removal time	4		$3.3 \pm 0.3$	3.0	3.0	
( CLR , PR )	t <sub>rem</sub>	_	$5.0 \pm 0.5$	2.0	2.0	ns

### AC Characteristics (C<sub>L</sub> = 50 pF, R<sub>L</sub> = 500 $\Omega$ , input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
	- <b>,</b>		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
Propagation delay time $ (\text{CK-Q}, \ \overline{\textbf{Q}} \ ) $	t <sub>pLH</sub>	_	$3.3 \pm 0.3$ $5.0 \pm 0.5$	_ _	8.2 6.1	13.9 8.7	1.0 1.0	16.0 10.0	ns
Propagation delay time (CLR, PR-Q, Q)	t <sub>pLH</sub>	_	$3.3 \pm 0.3$ $5.0 \pm 0.5$	_ _	8.5 6.4	14.4 9.1	1.0 1.0	16.6 10.5	ns
Maximum clock frequency	f <sub>max</sub>		$3.3 \pm 0.3$ $5.0 \pm 0.5$	55 100	120 160	_ _	55 100	_	MHz
Input capacitance	C <sub>IN</sub>			_	5	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub> (Note)			_	82	_	_	_	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

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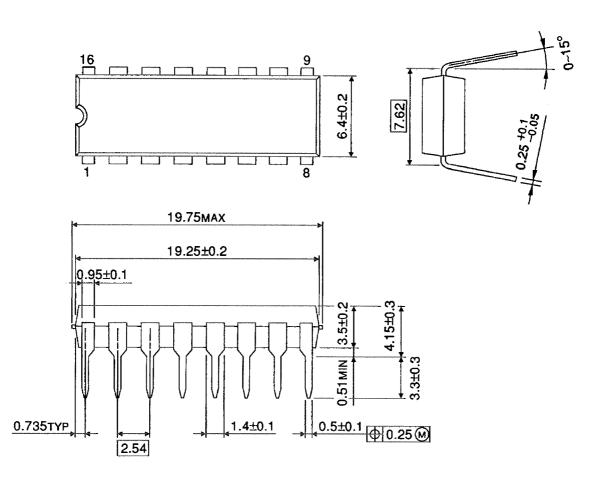
Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) =  $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2$  (per F/F)



# **Package Dimensions**

DIP16-P-300-2.54A Unit: mm



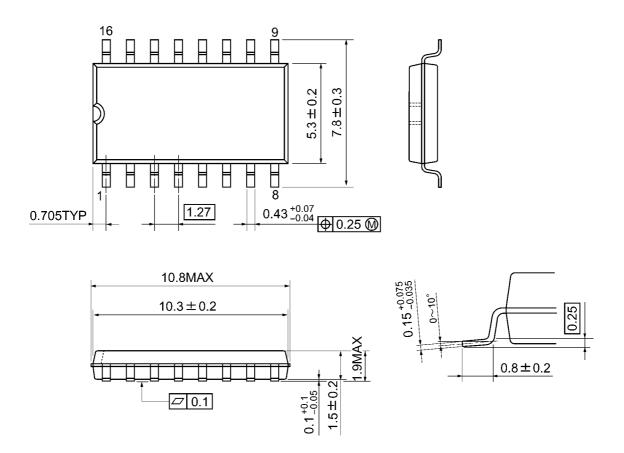
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Weight: 1.00 g (typ.)



## **Package Dimensions**

SOP16-P-300-1.27A Unit: mm

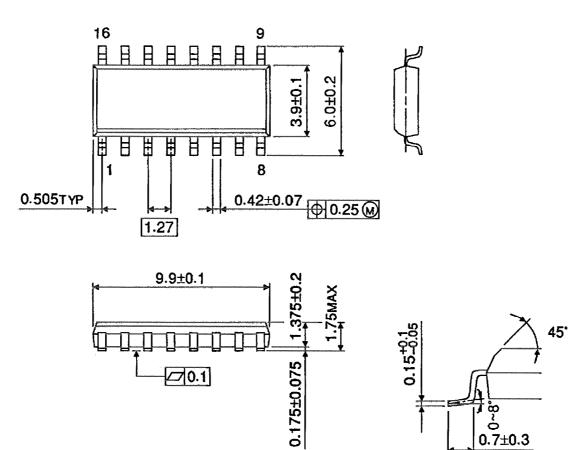


Weight: 0.18 g (typ.)



# **Package Dimensions (Note)**

SOL16-P-150-1.27 Unit: mm



Note: This package is not available in Japan.

Weight: 0.13 g (typ.)

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